



FX29 COMPRESSION LOAD CELL

- Versatile Miniature Force Sensor
- mV, Amplified, and Digital Outputs
- Low Power Consumption
- Rugged Microfused Sensing Element
- Stainless Steel Enclosure
- Several Load Ranges

FEATURES

- Compact Design
- mV or Amplified Analog Outputs
- Optional I²C Digital Interface
- High Over Range Capability

APPLICATIONS

- Medical Infusion Pumps
- Analog & Digital Scales
- Fitness & Exercise Equipment
- Payload Weighing
- Power Tools
- Robotics
- Surgical & Dental Tools
- Battery Powered Devices
- Manufacturing Equipment

TE Connectivity's (TE) FX29 is a compact compression load cell that offers exceptional price-to-performance in a robust sensor package. Optimized for embedded force sensing applications from disposable medical devices to durable appliances and exercise equipment. The FX29 allows design flexibility with mV, amplified, and digital output options.

The FX29 incorporates the high reliability Microfused technology and is offered in ranges from 10lbf to 100lbf (50N to 500N). Microfused technology provides excellent span and zero stability, outstanding cycle life, superior resolution, high over-range capabilities, and an unamplified span sensitivity of 20mV/V.

The FX29 utilizes a two-piece construction of stainless steel materials. The combination of a metal injection molded flexure and micro miniaturized MEMS strain gauges allows flexibility of force range options for a lower cost sensor. These improvements over previous load cell designs give the FX29 more precise dimensional control and better performance.

FX29 COMPRESSION LOAD CELL

Absolute Maximum Ratings (Analog)⁽¹⁾

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply voltage	V_{dd}			6.0	V	Analog mV Output
				5.25	V	Analog 0.5-4.5V Output
Storage temperature	T_s	-40		+85	°C	
Compressive load	L_{max}			2.5X	Rated	
ESD		-4.0		4.0	kV	Human Body Model

⁽¹⁾ Maximum limits the device will withstand without damage

Standard Load Ranges

Pounds-Force (lbf)	Newton's (N)
10	50
25	125
50	250
100	500

Electrical Specifications (Analog)

(Unless otherwise specified, all parameters are measured at 25°C @ 5.0V applied)

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply voltage (V_{supply})	V_{dd}	1.00		6.0	V	mV Output only
		4.75		5.25	V	0.5-4.5V Output only
Operating current	I_{dd}			3	mA	0.5-4.5V Output only
Input resistance	R_{in}	2.4	3.0	3.6	kΩ	mV Output only
Output resistance	R_{out}	1.76	2.2	2.64	kΩ	mV Output only
Rise time	T_r			2.0	ms	10% to 90%
Maximum output current	I_o	2.2			mA	0.5-4.5V Output only
Output short circuit duration	T_s			∞	seconds	0.5-4.5V Output only
Insulation resistance		50			MΩ	@250VDC
Bandwidth				1.0	kHz	

FX29 COMPRESSION LOAD CELL

Operating Specifications (Analog)

(Unless otherwise specified, all parameters are measured at 25°C @ 5.0V applied)

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Zero offset ¹		-15		15	mV/V	mV Output only
		300	500	700	mV	0.5-4.5V Output only
Full scale span ¹		16	20	24	mV/V	mV Output only
		3800	4000	4200	mV	0.5-4.5V Output only
Non-linearity		-1		1	%Span	BFSL
Hysteresis		-0.8		0.8	%Span	
Zero repeatability		-0.8		0.8	%Span	
Span repeatability		-0.8		0.8	%Span	
Thermal shift for zero		-0.05		0.05	%Span/°C	Reference to 25°C, over compensated temperature
Thermal shift for span		-0.05		0.05	%Span/°C	
Cycle life		1E+6				0 to full scale cycles
Deflection at rated load				0.03	mm	
Weight			6.0		grams	Without ribbon cable

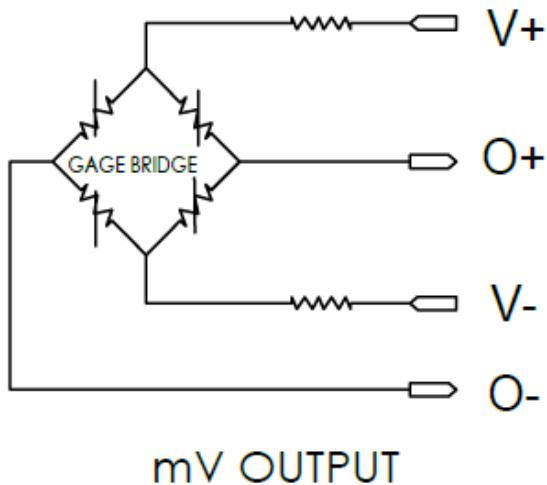
⁽¹⁾Span and zero offset are ratiometric to power supply voltage

Environmental Specifications (Analog)

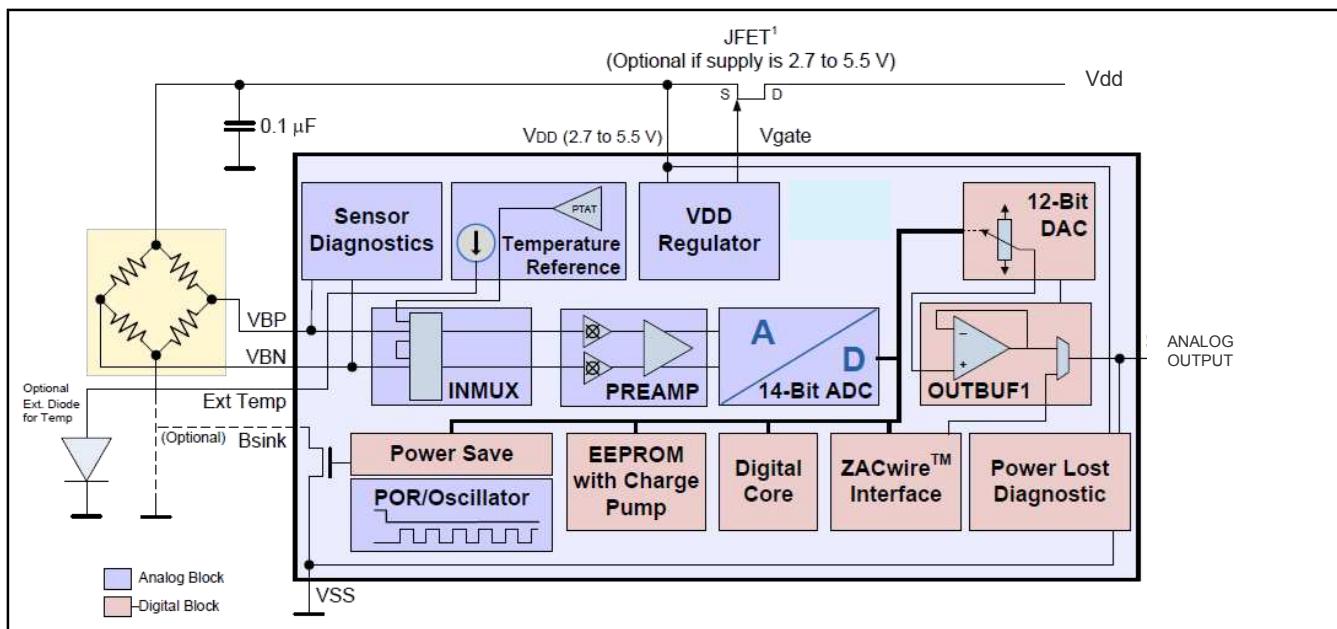
(Unless otherwise specified, all parameters are measured at 25°C @ 5.0V applied)

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Compensated temperature range	T _o	0		50	°C	0.5-4.5V Output only
Storage temperature	T _s	-40		85	°C	
Ambient humidity		0		85	%RH	Non-condensing
EMI/RFI/ESD protection		IEC61000-4-2 (8kV _{air} /4kV _{contact}) IEC61000-4-3 (3V/m) IEC55032 Class A				mV Output only
Ingress protection	IP	43				
Media compatibility		External exposed surfaces: 17-4 and 304 stainless steel				Excluding cable & connector

Schematic Diagram – mV output (Analog)



Block Diagram – 0.5 to 4.5V output (Analog)



FX29 COMPRESSION LOAD CELL

Absolute Maximum Ratings (Digital)⁽¹⁾

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply voltage				5.50	V	
Storage temperature	T _S	-40		+85	°C	
Compressive load	L _{max}			2.5X	Rated	
ESD		-4.0		4.0	kV	Human Body Model

⁽¹⁾Maximum limits the device will withstand without damage

Standard Load Ranges

Pounds-Force (lbf)	Newton's (N)
10	50
25	125
50	250
100	500

Electrical Specifications (Digital)

(Unless otherwise specified, all parameters are measured at 25°C @ 3.0V applied)

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply voltage (V _{supply})	V _{dd}	2.7		5.5	V	
Operating current	I _{dd}			3	mA	
Sleep mode current	I _{slp}		0.5	5	µA	
Insulation resistance		50			MΩ	@250VDC

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Force Operating Specifications (Digital)

(Unless otherwise specified, all parameters are measured at 25°C @ 3.0V applied)

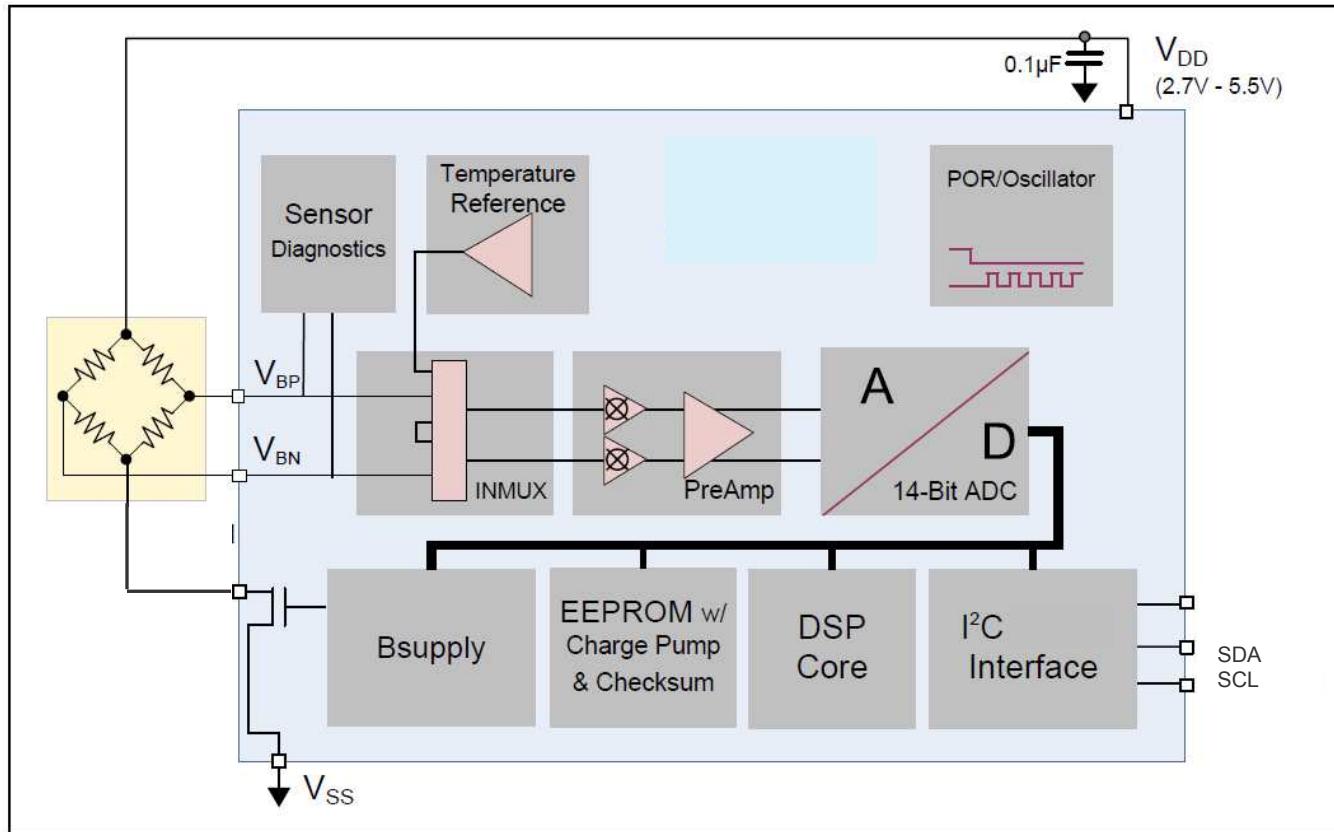
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Zero offset		300	1000	1700	Counts	Base ₁₀
Full scale span		14300	15000	15700	Counts	Base ₁₀
Non-linearity		-1		1	%Span	BFSL
Hysteresis		-0.8		0.8	%Span	
Zero repeatability		-0.8		0.8	%Span	
Span repeatability		-0.8		0.8	%Span	
Thermal shift for zero		-0.05		0.05	%Span/°C	Reference to 25°C, over compensated temperature
Thermal shift for span		-0.05		0.05	%Span/°C	
Cycle life		1E+6				0 to full scale cycles
A/D resolution			14		Bits	
Response time				3	mS	4MHz, non-sleep mode
				8.4	mS	4MHz, sleep mode
Deflection at rated load				0.03	mm	
Weight			6.0		grams	Without ribbon cable

Environmental Specifications (Digital)

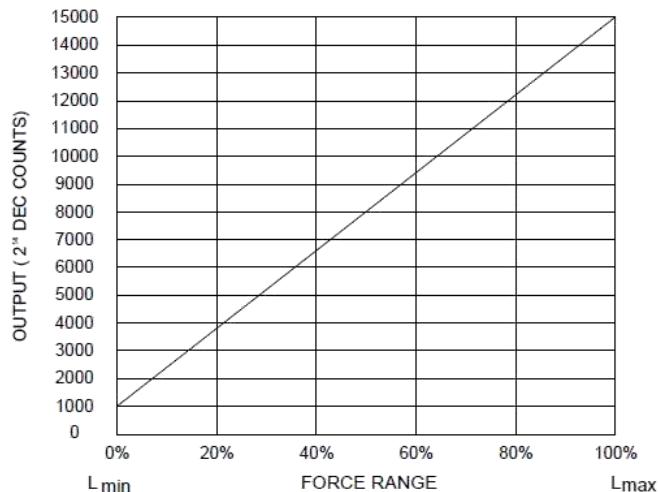
(Unless otherwise specified, all parameters are measured at 25°C @ 3.0V applied)

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Compensated temperature range	T _o	0		50	°C	
Storage temperature	T _s	-40		85	°C	
Ambient humidity		0		85	%RH	Non-condensing
Ingress protection	IP	43				
Media compatibility		External exposed surfaces: 17-4 and 304 stainless steel			Excluding cable & connector	

Block Diagram – I²C Digital Output (Digital)



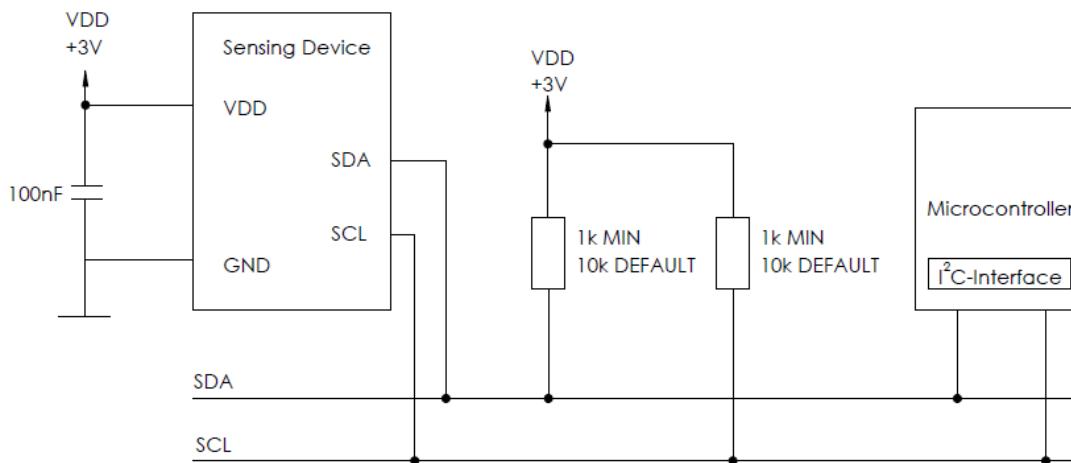
Force Output Graph (Digital)



$$OUTPUT \text{ (decimal counts)} = \frac{14000}{LOAD \text{ RANGE}} * FORCE + 1000$$

Force Sensor Output		
%Output	Counts (decimal)	Counts (hex)
0%	1000	0x3E8
5%	1700	0x6A4
10%	2400	0x960
50%	8000	0x1F40
90%	13600	0x3250
95%	14300	0x37DC
100%	15000	0x3A98

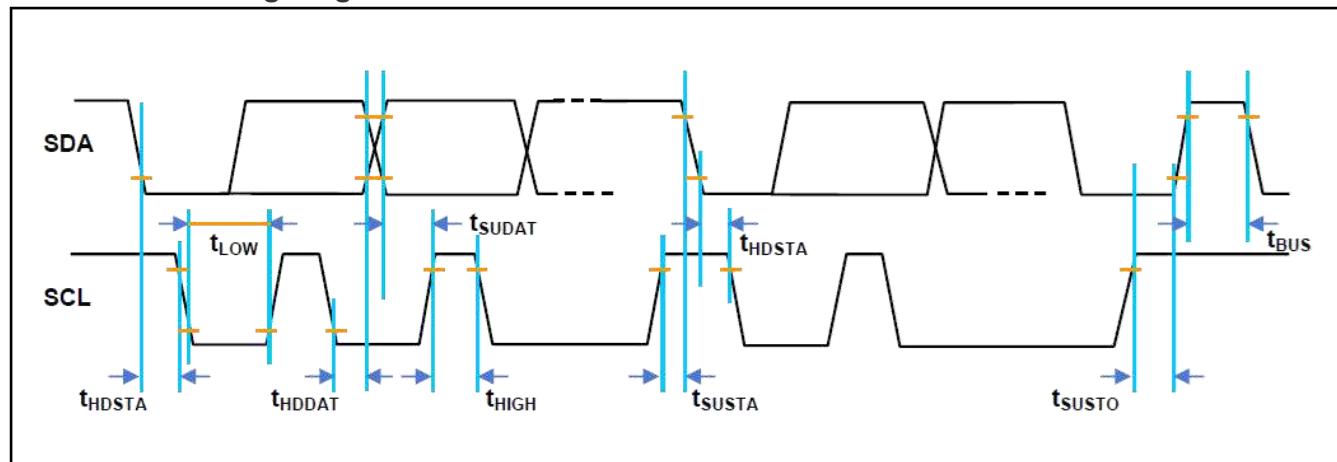
I²C Typical Circuit



Note: only one pair of pull up resistors are needed for multiple sensing devices.

I²C Interface

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
SCLK clock frequency	FSCL	100		400	kHz	
Start condition hold time relative to SCL edge	t _{HOSTA}	0.1			μS	
Minimum SCL clock low width ¹	t _{LOW}	0.6			μS	
Minimum SCL clock high width ¹	t _{HIGH}	0.6			μS	
Start condition startup time relative to SCL edge	t _{SUSTA}	0.1			μS	
Data hold time on SDA relative to SCL edge	t _{HDDAT}	0			μS	
Data setup time on SDA relative to SCL edge	t _{SUDAT}	0.1			μS	
Stop condition setup time on SCL	t _{SUSTO}	0.1			μS	
Bus free time between stop and start condition	t _{BUS}	2			μS	

I²C Interface Timing Diagram

Digital Input and Output Parameters

(Unless otherwise specified, all parameters are measured at 25°C @ 3.0V applied)

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Input high voltage	V _{IH}	0.8		1.0	x Vdd	
Input low voltage	V _{IL}	0.0V		0.2	x Vdd	
Output low level					x Vdd	
Load capacitance @ SDA				200	pF	@400 kHz
Input capacitance (each pin)				10	pF	

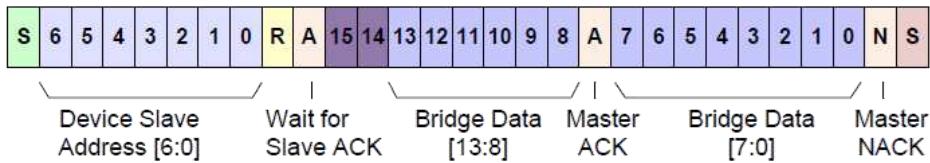
I²C Measurement Packet Read Sequence

(1) I²C Read_MR – Measurement Request:
Slave starts a measurement and DSP calculation cycle.

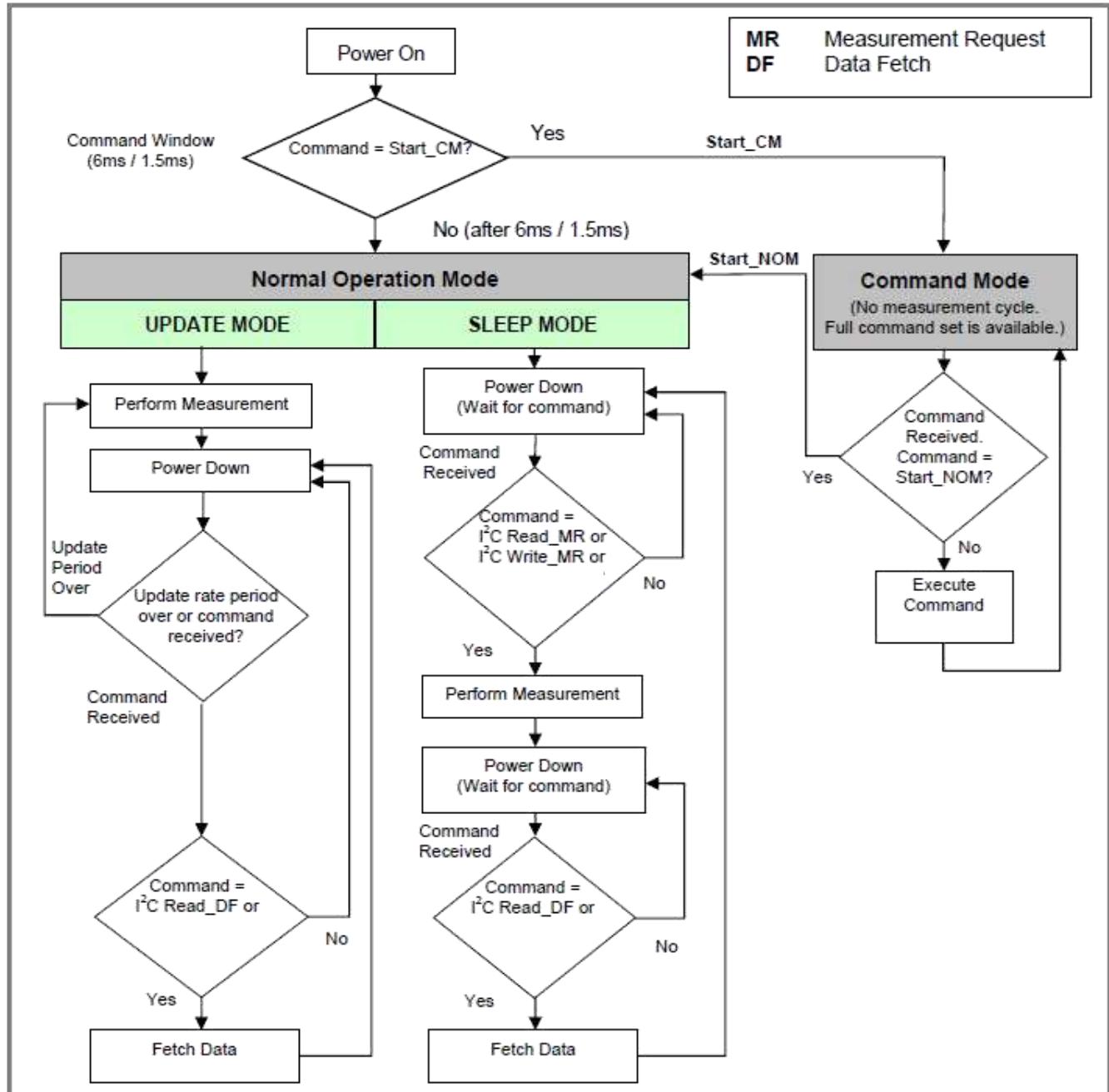


S	Start Condition
5	Device Slave Address (example: Bit 5)
2	Data Bit (example: Bit 2)
R	Read/Write Bit (example: Read=1)
A	Acknowledge (ACK)
N	No Acknowledge (NACK)
S	Stop Condition
	Status Bit

(2) I²C Read_DF2 – Data Fetch 2 Bytes:
Slave returns only bridge data to the master in 2 bytes.

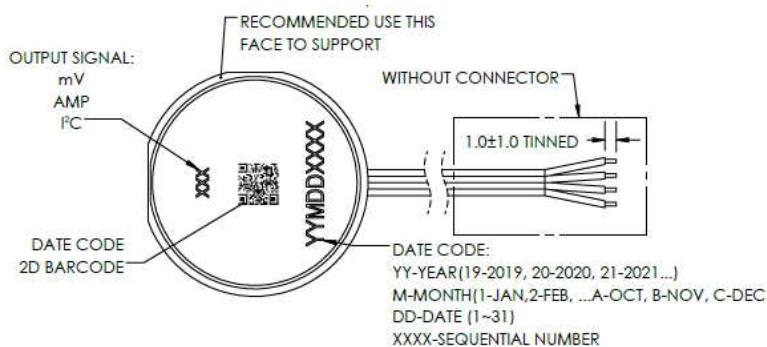
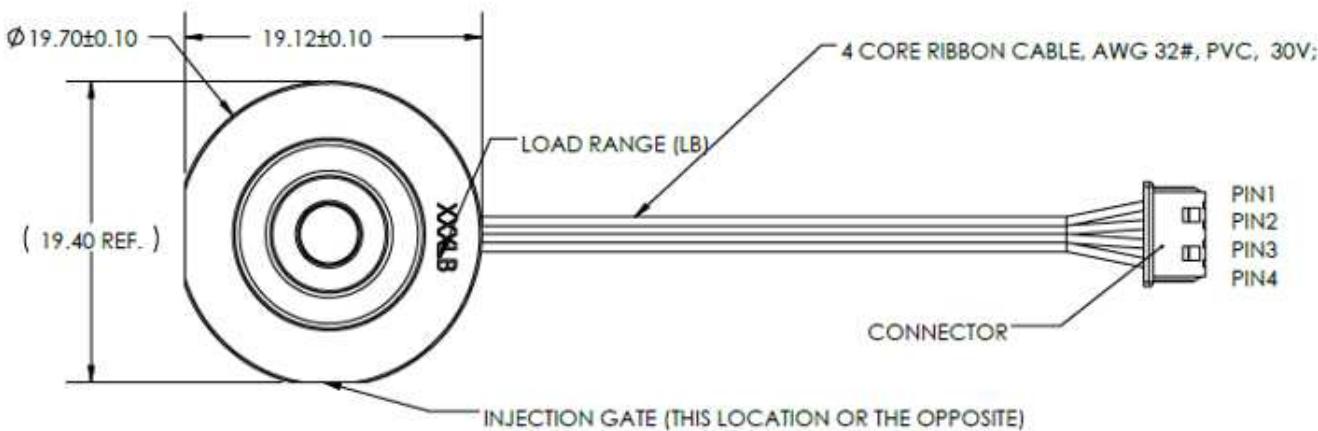


General Working Mode



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Outline Drawing and Connections



CONNECTIONS INFORMATION:

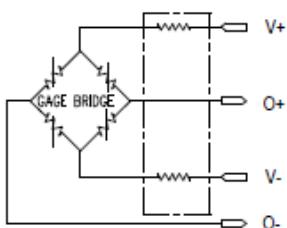
PIN	WIRE COLOR	OUTPUT SIGNAL		
		mV	0.5~4.5V	I ² C
1	RED	V+	V+	V+
2	YELLOW	O+	O+	SCL
3	WHITE	O-	N/A	SDA
4	BLACK	V-	COMMON	V-

CONNECTOR INFORMATION:

BRAND	PART	DESCRIPTION	MATING RECOMMENDATION
TE	HOUSING	TE: # 440146-4, CONN RCPT 4POS SGL 1.25MM NATRL	TE: # 1734598-4, CONN HEADER VERT 4POS 1.25MM
	TERMINAL	TE: # 1734193-1, CONN SOCKET 28-32AWG CRIMP TIN	

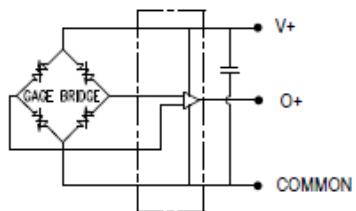
mV OUTPUT

WIRING INFORMATION



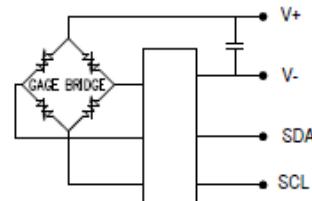
0.5~4.5V OUTPUT

WIRING INFORMATION



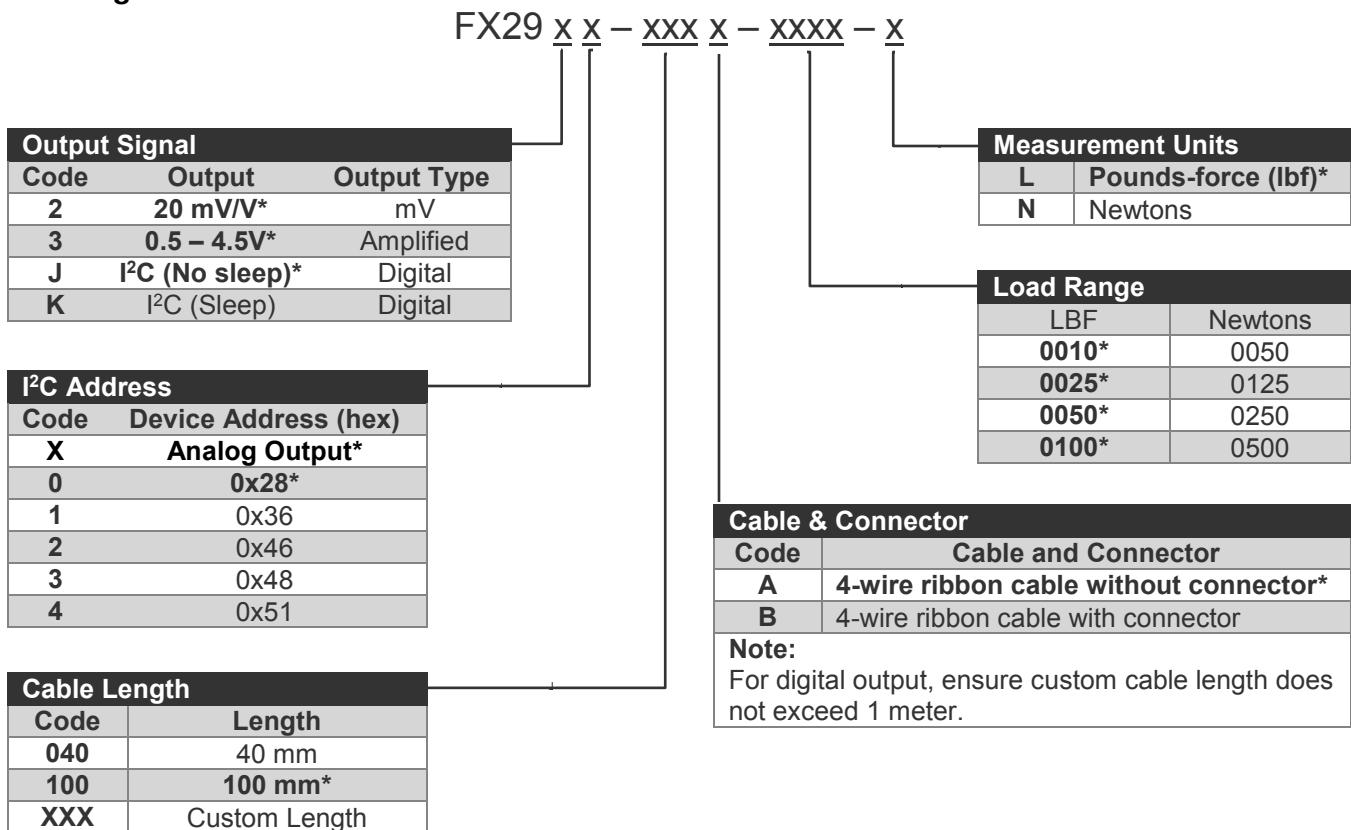
I²C OUTPUT

WIRING INFORMATION



FX29 COMPRESSION LOAD CELL

Ordering Information



*Sensor features shown in **bold** are typically stocked by our distribution partners, or available with short lead times from the factory depending on availability. Contact customer service for details.

REVISION HISTORY

Revision Number	Change Description	Date	Approval
A0	Initial release	05/13/2019	PRS
A3	Minor corrections ;	06/24/2019	MH